| Electronic Patent Application Fee Transmittal | | | | | | | |
|---|--|----------|----------|--------|-------------------------|--|--|
| Application Number: | 10655854 | | | | | | |
| Filing Date: | 05-Sep-2003 | | | | | | |
| Title of Invention: | Multi-layer integrated semiconductor structure | | | | | | |
| First Named Inventor/Applicant Name: | Rafael Reif | | | | | | |
| Filer: | Christopher S. Daly | | | | | | |
| Attorney Docket Number: | MIT-136AUS | | | | | | |
| Filed as Small Entity | | | | | | | |
| Utility under 35 USC 111(a) Filing Fees | | | | | | | |
| Description | | Fee Code | Quantity | Amount | Sub-Total in USD(\$) | | |
| Basic Filing: | | | | | | | |
| Pages: | | | | | | | |
| Claims: | | | | | | | |
| Miscellaneous-Filing: | | | | | | | |
| Petition: | | | | | | | |
| Patent-Appeals-and-Interference: | | | | | | | |
| Post-Allowance-and-Post-Issuance: | | | | | | | |
| Extension-of-Time: | | | | | | | |
| Extension - 3 months with \$0 paid | | 2253 | 1 | 555 | 555 | | |

| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
|----------------|-------------------|----------|--------|-------------------------|
| Miscellaneous: | | | | |
| | Total in USD (\$) | | | 555 |